

## Type 3522 Series

#### **Key Features**

3 Watts at 70°C

Small size to power ratio

Supplied on tape

Value marked on resistor

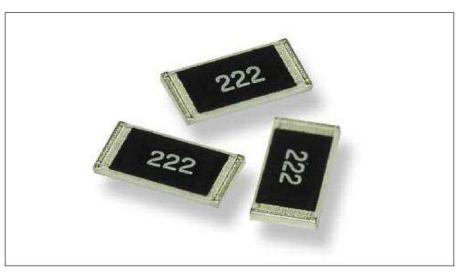
Available via distribution

500 volt maximum overload

250 volt working voltage

Terminal finish matte Sn over Ni

AEC-Q200 Qualified



TE Connectivity is pleased to announce that our 3522 series resistor is now AEC-Q200 qualified. This low cost high power device, suitable for auto placement in volume and for most applications, including high frequency operations, owing to the short lead structure is supplied as standard on 7 inch Reels of 2000 pieces per reel.

#### **Characteristics – Electrical**

Power rating at 70°C	3W
Rated current (Jumper)	2.5A
Max. overload current (Jumper)	10A
Max working voltage	250V
Max overload voltage	500V
Dielectric withstand voltage	500V
Temperature range	-55°C ~ +155°C
Ambient temperature	70°C

\* Rated continuous working voltage (RCWV) shall be determined from

RCWV = V(Rated Power x Resistance Value), or Maximum RCWV listed above, whichever is less

\*\*Recommended Circuit Board Design - If this device is anticipated to run at full continuous power then action to improve the cooling should be taken. This can be a metal substrate, copper pad left under the chip, an opening in the PCB or enlarged silver conductor pads each end.

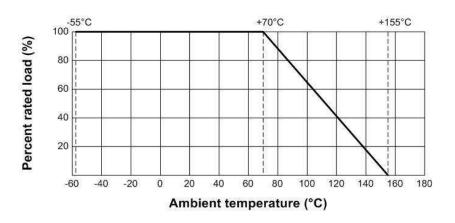
#### 9-1773463-7 Rev. G 04/2020

Dimensions in millimetres unless otherwise specified Dimensions Shown for reference purposes only. Specifications subject to change

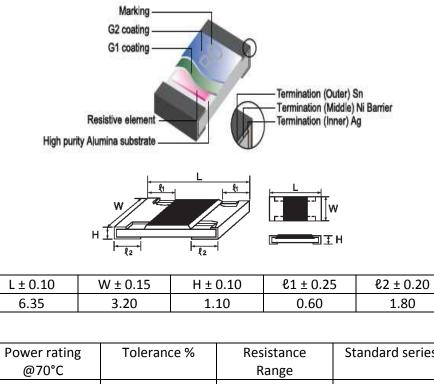


## Power derating curve

For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with this curve.



## **Construction and dimensions**



Power rating	Tolerance %	Resistance	Standard series
@70°C		Range	
	Jumper	<50mΩ	
3W	± 1%	1Ω - 10ΜΩ	E96
	± 5%	1Ω - 10ΜΩ	E24

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## Performance specification

Characteristics	Limits	Test Methods	
		125⊡, at35% of operating power,	
Operational life	±(1%+0.1Ω)max	1000H(1.5 hours "ON", 0.5 hour	
Operational life		"OFF"). (MIL-STD-202)	
	<100mΩ	Apply to rate current for 0 Ω	
		Parametrically test per lot and	
	$1\Omega \le R \le 10\Omega \le \pm 400$ PPM/°C	sample size requirements, summary	
Temperature	$10\Omega < R \le 100\Omega \le \pm 200PPM/°C$ $100\Omega < R \le 100\Omega \le \pm 100\Omega \le \pm 100PPM/°C$	to show Min, Max, Mean and	
Coefficient of		Standard deviation at room as well as	
Resistance		Min and Max operating	
		temperatures. (User Spec)	
		Electrical test not required. Inspect	
External Visual	No Machanical Damaga	device construction, marking and	
External visual	No Mechanical Damage	workmanship	
		(MIL-STD-883 Method 2009)	
		Verify physical dimensions to the	
Physical	Reference 2.0 Dimension	applicable device detail specification	
dimension	standards	Note: User(s) and Suppliers spec.	
uinension	stanuarus	Electrical test not required.	
		(JESD22 MH Method JB-100)	
		Note: Add Aqueous wash chemical –	
Resistance to	Marking Unsmeared	OKEM Clean or equivalent.	
solvent		Do not use banned solvents.	
		( MIL-STD-202 Method 215)	
Terminal	Not broken	Force of 1.8kg for 60 seconds.	
Strength	Not broken	(JIS-C-6429)	
High		1000hrs. @T=155°C.Unpowered.	
Temperature	±(1%+0.1Ω)max	Measurement at 24±2 hours after	
Exposure		test conclusion.	
(storage)		(MIL-STD-202 Method 108)	
(3001080)	<50mΩ	Apply to rate current for 0 $\Omega$	
		1000 Cycles (-55°C to +155°C).	
Temperature	Resistance change rate is ±(0.5%+0.1Ω) Max	Measurement at 24±2 hours after	
cycling		test conclusion	
		(JESD22 Method JA-104)	
	<50mΩ	Apply to rate current for 0 Ω	
Moisture Resistance	Resistance change rate is ± (0.5%+0.1Ω) Max.	255 255 375 256 256 256 256 256 256 256 25	
		T=24 hours /cycle. Unpowered.	
		Measurement at 24±2 hours	
		after test conclusion.	
		(MIL-STD-202 Method 106)	
	<50mΩ	Apply to rate current for 0 $\Omega$	
		10% rated power, 85°C/85% RH,	
Biased Humidity	Resistance change rate is	1000H,	
	$\pm (1\%+0.1\Omega)$ Max.	Measurement at 24 hours after test	
y	(,,	conclusion	
		(MIL-STD-202 Method 103)	
	<100mΩ	Apply to rate current for 0 $\Omega$	

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Characteristics	Limits	Test Methods		
Characteristics		Wave Form: Tolerance for half sine		
Mechanical		shock pulse. Peak value is 100g's.		
Shock	±(1%+0.1Ω)max	Normal duration (D) is 6.		
SHOCK		(MIL-STD-202 Method 213)		
		5g's for 20 min., 12cycle each of 3		
		orientations		
		Note: Use 8"*5"PCB. 031" thick 7		
		secure points on one long side and 2		
Vibration	±(1%+0.1Ω)max	secure points of orners of opposite		
VIDIATION	1(1/0+0.132)/max	sides. Parts mounted within 2' from		
		any secure point.		
		Test from 10-2000Hz.		
		(MIL-STD-202 Method 204)		
		-55°C/+155°C, Note: Number of		
		cycles required - 300,		
	±(1%+0.1Ω)max	Maximum transfer time -20 seconds,		
Thermal Shock	1(1/0+0.132)/max	Dwell time -15 minutes. Air-Air.		
		(MIL-STD-202 Method 107)		
	<50mΩ	Apply to rate current for $0\Omega$		
	301122	With the electrometer in direct		
		contact with the discharge tip, verify		
		the voltage setting at levels of		
		±500V, ±1KV, ±2KV, ±4KV, ±8KV, The		
ESD	±(10%+0.1Ω)max	electrometer reading shall be within		
		±10% for voltages from 500V to		
		≦800V.		
		(AEC-Q200-002)		
		For both leaded & SMD. Electrical		
		test not required.		
		Magnification 50X. Conditions:		
		a) Method B 4hrs at 155°C dry heat,		
Solderability	95% coverage Min.	the dip in bath with 245°C, 5s.		
		b) Method B: at 215°C, 5s.		
		c) Method D: at 260°C, 60s.		
		(J-STD-002)		
	No ignition of the tissue paper	V-0 or V-1 are acceptable. Electrical		
Flammability	or scorching of the pinewood	test not required.		
i la	board	(UL-94)		
	±(1%+0.05Ω)max	2mm (Min) (JIS-C-6429)		
Board Flex	<50mΩ	Apply to rate current for $0\Omega$		
		Temperature sensing at 500°C,		
		Voltage power subjected to 32VDC		
Flame	No flame	current clamped up to 500ADC and		
Retardance	No hame	decreased in 1.0VDC/hour.		
		(AEC-Q200-001)		
		Condition B No per-heat of samples.		
		Note: Single Wave Solder - Procedure		
Resistance to	±(1%+0.05Ω) max.	2 for SMD and Procedure 1 for		
Soldering Heat		Leaded with solder within 1.5mm of		
estacting ficut		device body.		
		(MIL-STD-202 Method 210)		
	<50mΩ	Apply to rate current for 0 W		
* Sulfuration test				
* Sulfuration test: H2S 3~5PPM 50 ±2 91%~93%RH 1000H				

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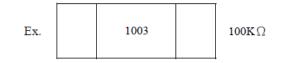
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## Marking:

Marking for E-96 series in 2512 size: 4 digit marking

First three digits are significant figures of resistance and the fourth digit represents the number of following zeros. N.B. For values below  $100\Omega$  the letter R denotes decimal point eg.  $1R80 = 1.8\Omega$ 



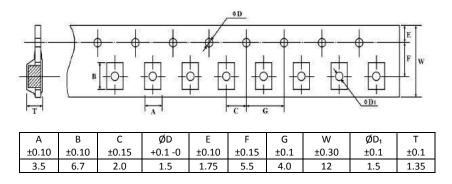
Marking for E-24 series in 2512 size: 3 digit marking

First two digits are significant figures, and the third digit represents the number of zeros



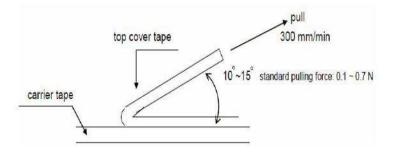
## **Packing specification:**

#### Taping dimensions (mm)



#### Peeling strength of Top Cover Tape

Test Condition 0.1 to 0.7 N at a peel-off speed of 300mm / min.

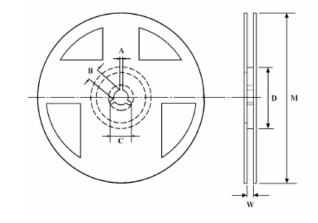


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## Reel dimension (mm)



Qty / Reel	A ±0.5	B ±0.5	C ±0.5	D ±1	M ±2	W ±1
2000	2	13	21	60	178	13.5

#### **Environment Related Substance**

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

#### Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chlorofluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs), Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

#### **Storage Condition**

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of  $25^{\circ}C \pm 10^{\circ}C$  and a relative humidity of 60%RH  $\pm 10\%$ RH, chemical and dust free atmosphere

Even within the above guarantee periods, do not store these products in the following conditions, otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2

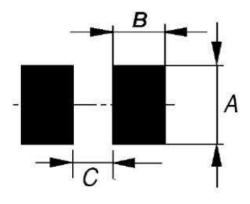
2. In direct sunlight

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## **Recommended solder pad**



А	В	С
3.70	3.30	2.70

4 layers PCB specification:

- 1) Outside 2 layers (Top and Bottom) with copper foil thickness at 2oz.
- 2) Inside 2 layers (Middle layers) with copper foil thickness at 4 oz.

### **AEC-Q200**

The 3522 series is qualified to AEC-Q200 standard at Grade"4"

#### How To Order

3522	1K0	F	Т
Common Part	Resistance Value	Tolerance	Pack Style
	1 ohm 1R0		
	1K ohm 1000 ohms		
3522	1KO	F — 1%	Т — 2000
		J — 5%	reel
	1 Meg ohm		
	1000000 ohms		
	1M0		

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